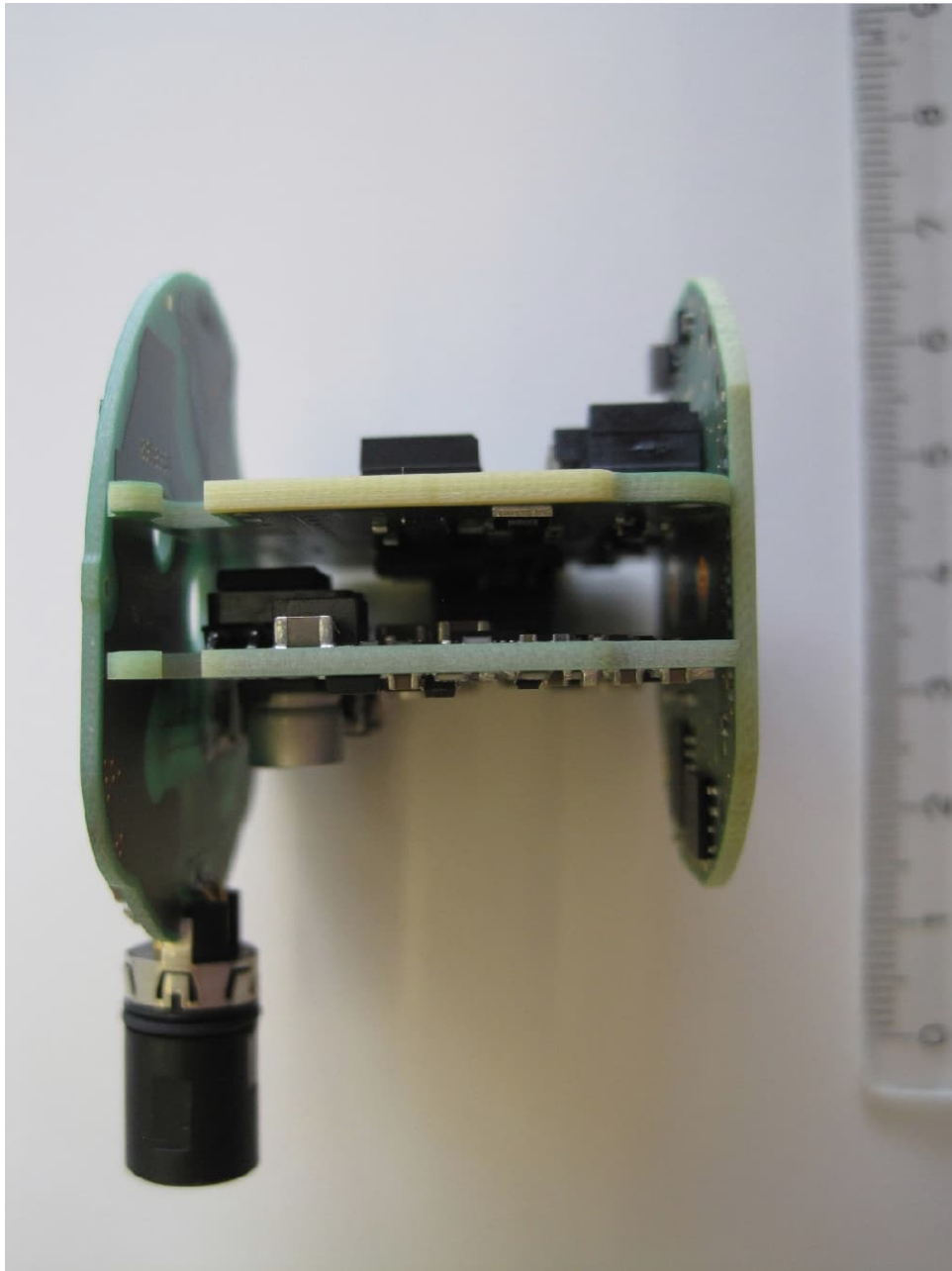


Internal photographs (supplied be the applicant)



Electronic housing

Internal photographs (supplied be the applicant)



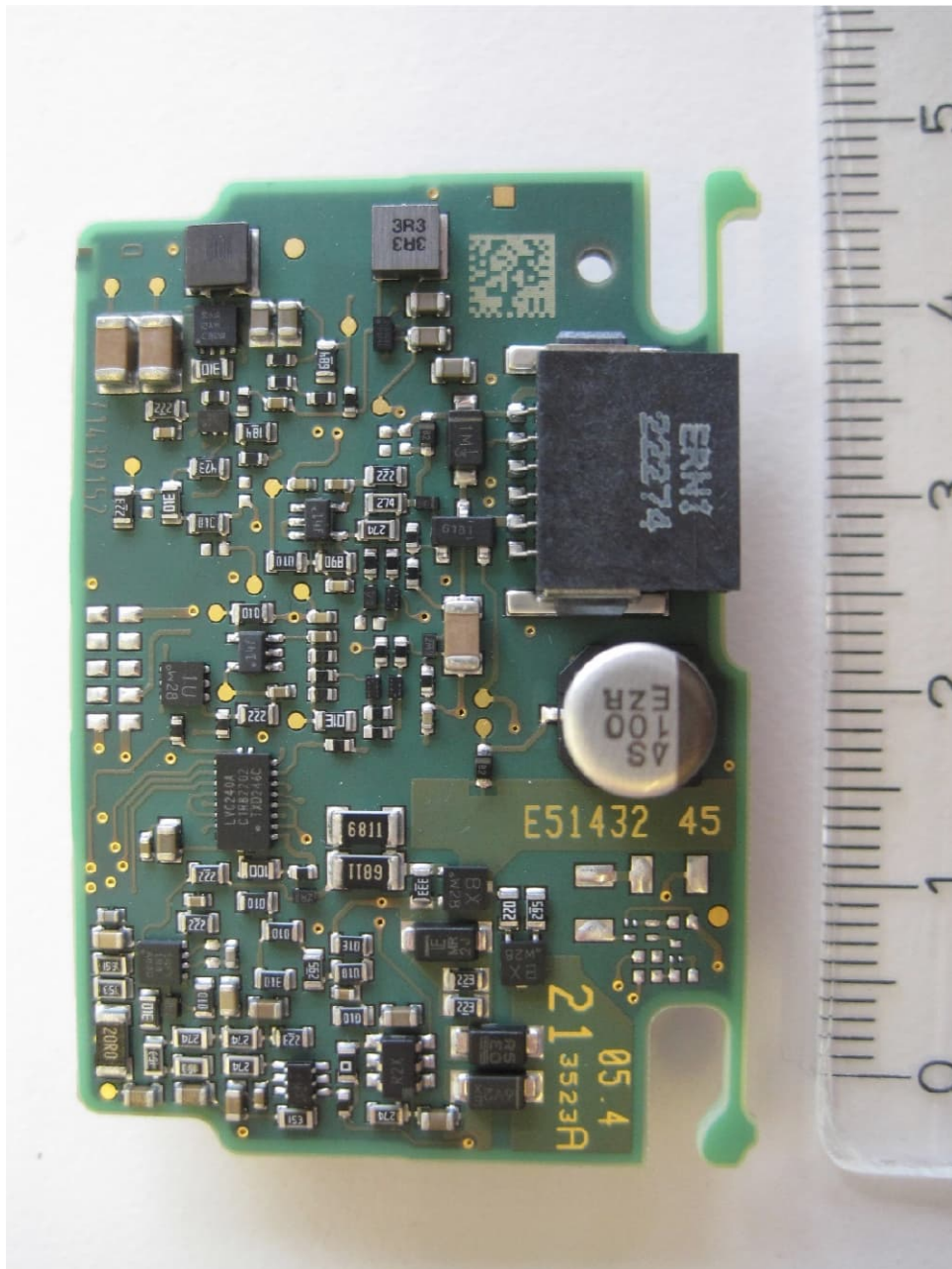
PCBs removed from electronic housing

Internal photographs (supplied be the applicant)



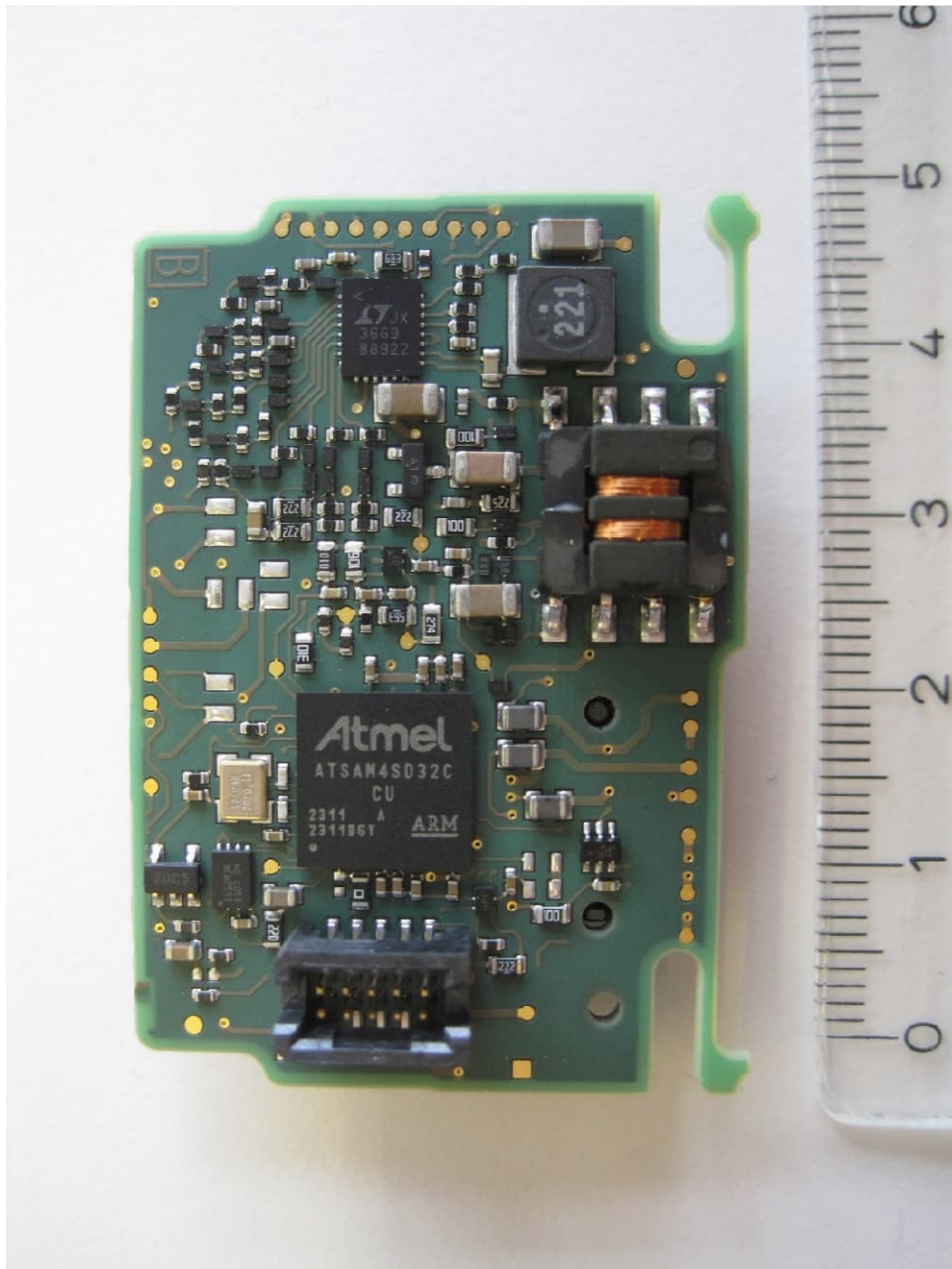
Mechanical parts

Internal photographs (supplied by the applicant)



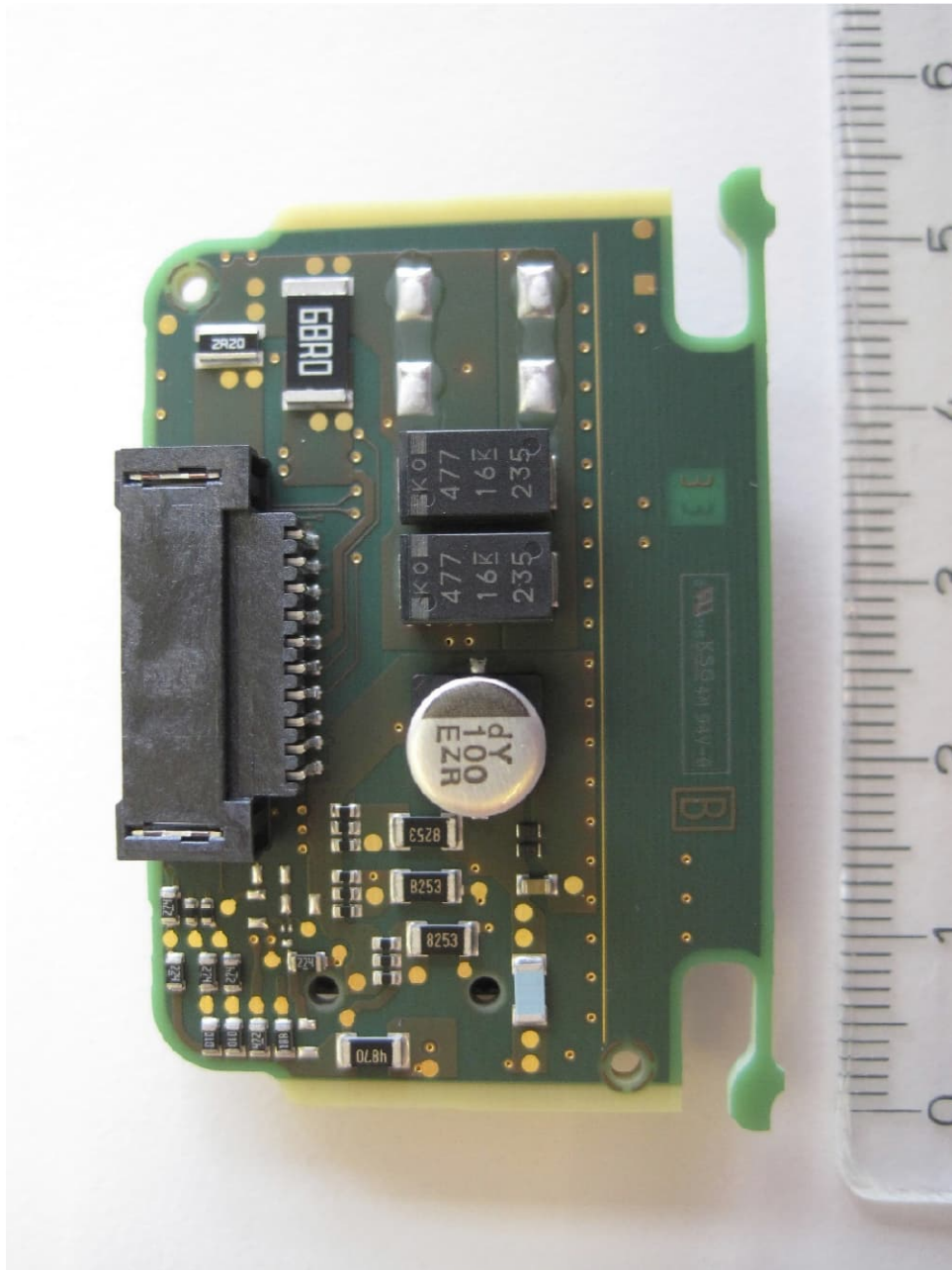
Main board, top view

Internal photographs (supplied by the applicant)



Main board, bottom view

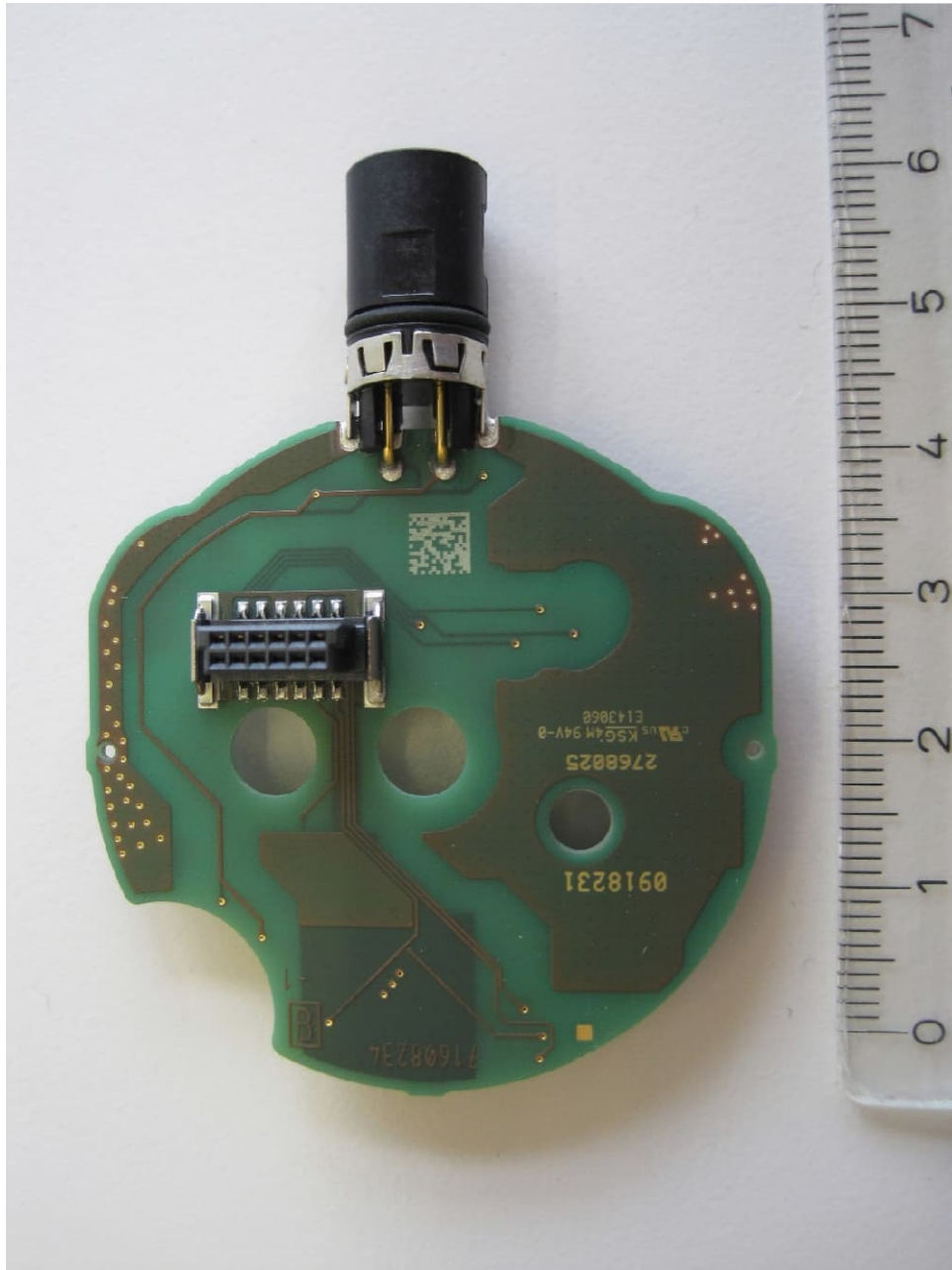
Internal photographs (supplied by the applicant)



Power board, top view

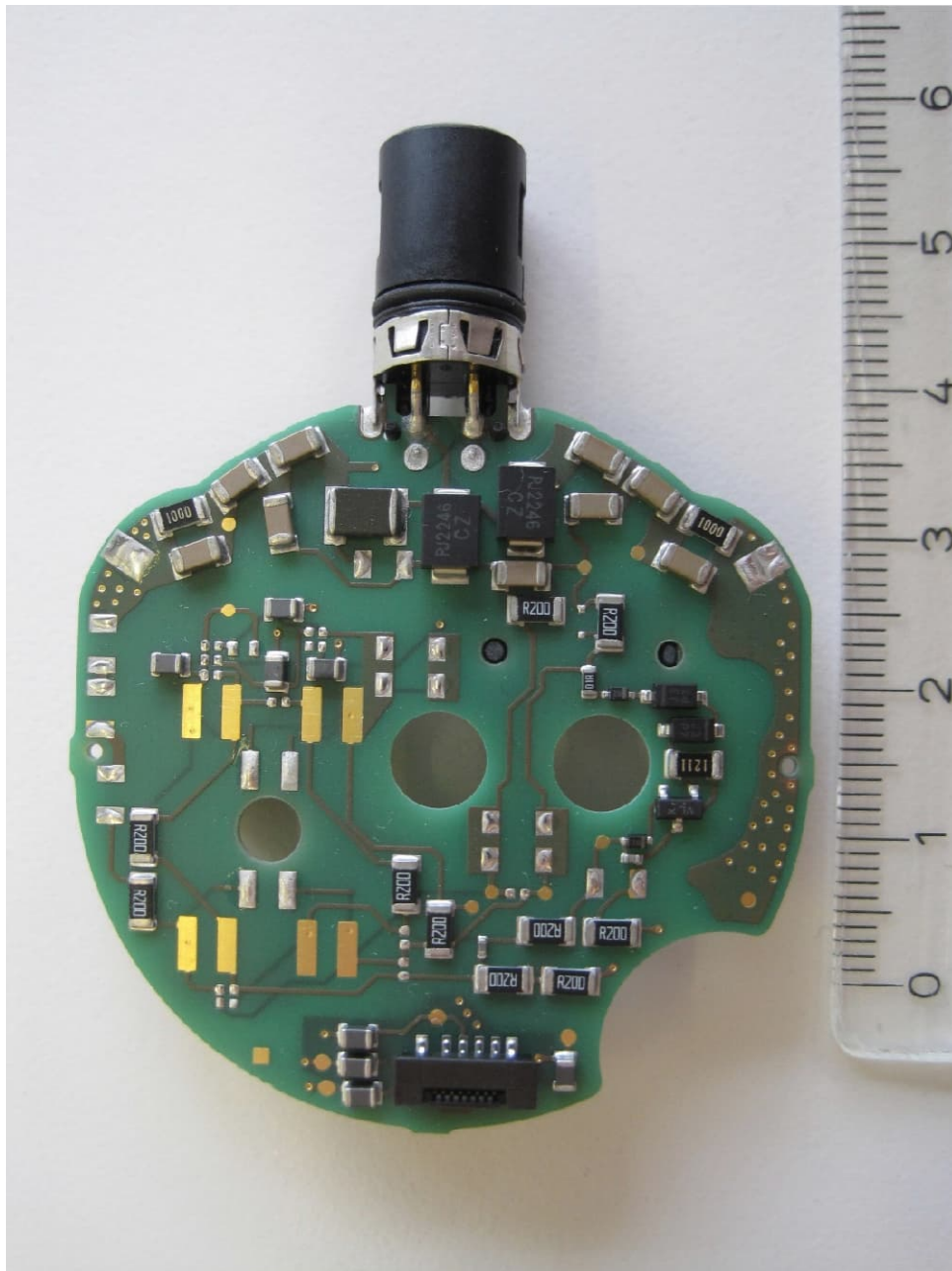


Internal photographs (supplied by the applicant)



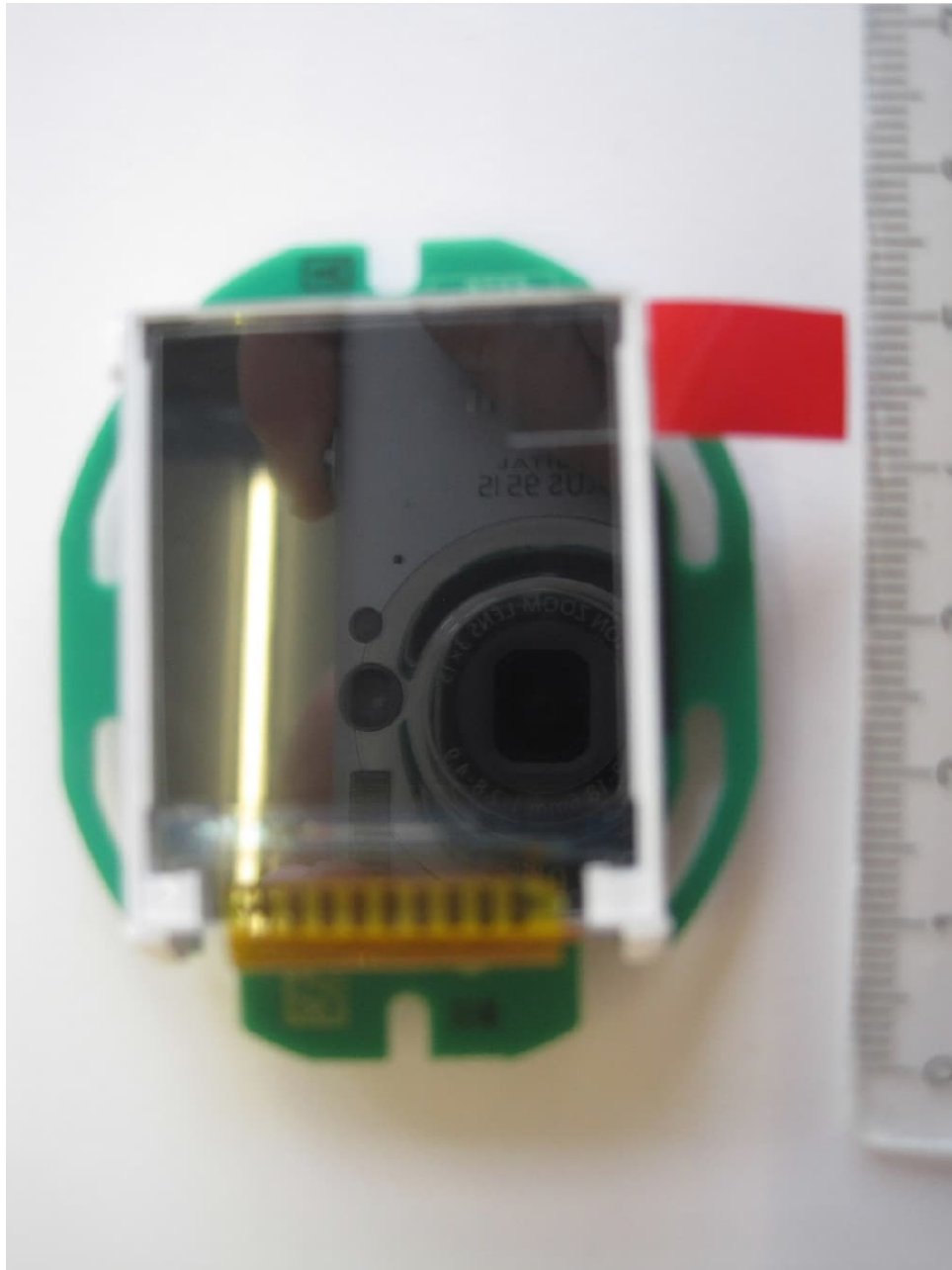
Terminal board, top view

Internal photographs (supplied be the applicant)



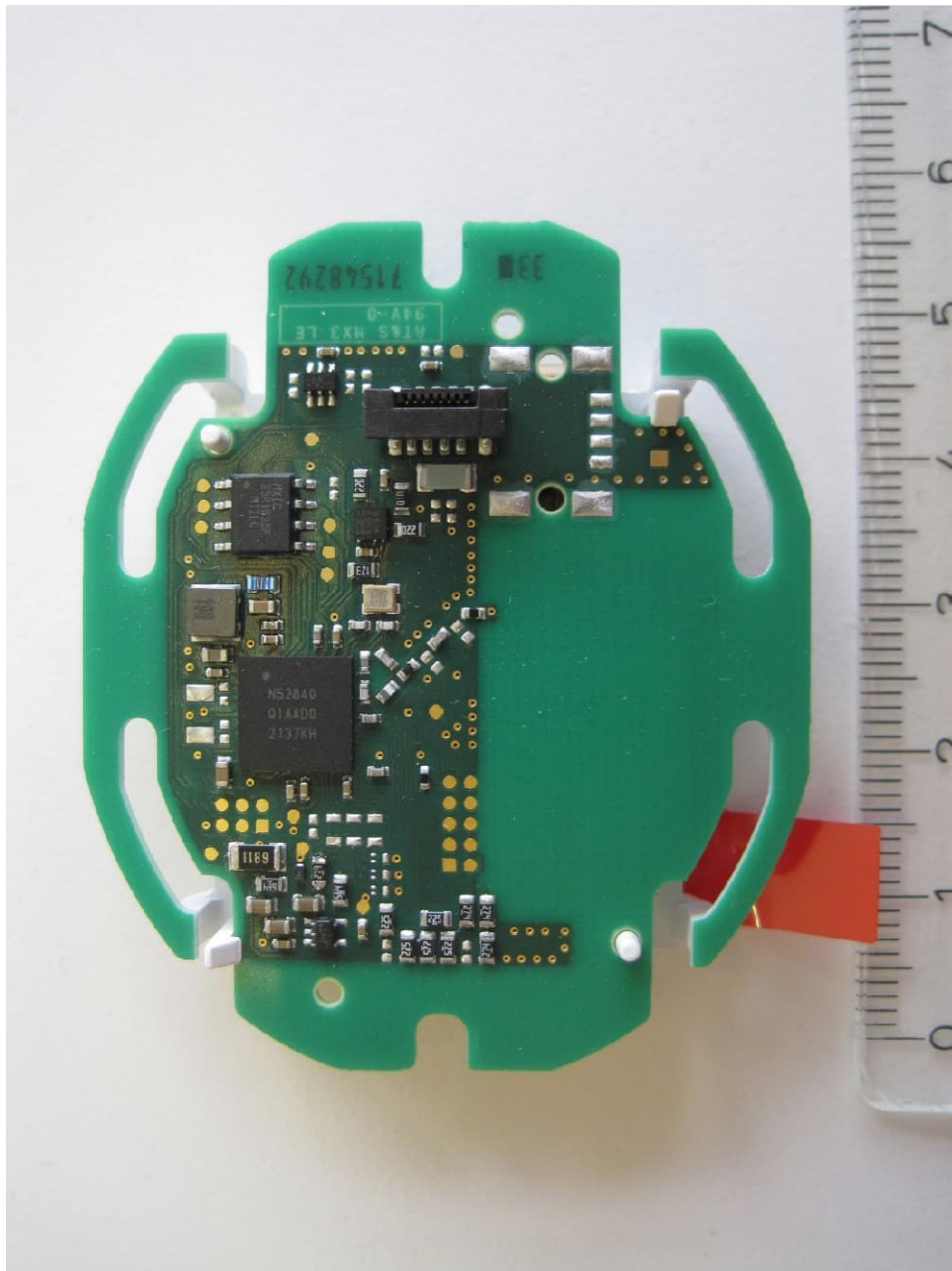
Terminal board, bottom view

Internal photographs (supplied by the applicant)



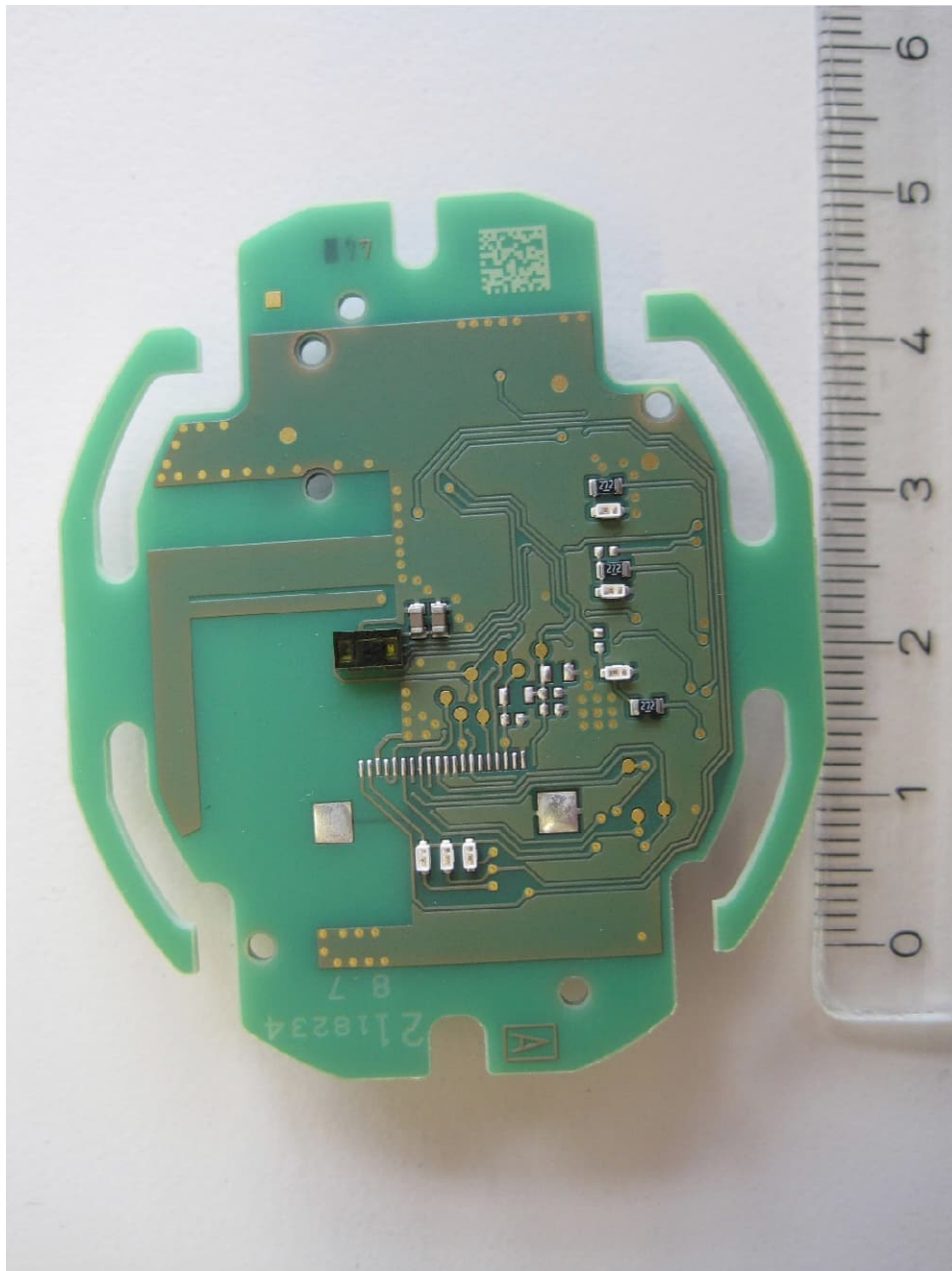
LCD board, top view

Internal photographs (supplied by the applicant)



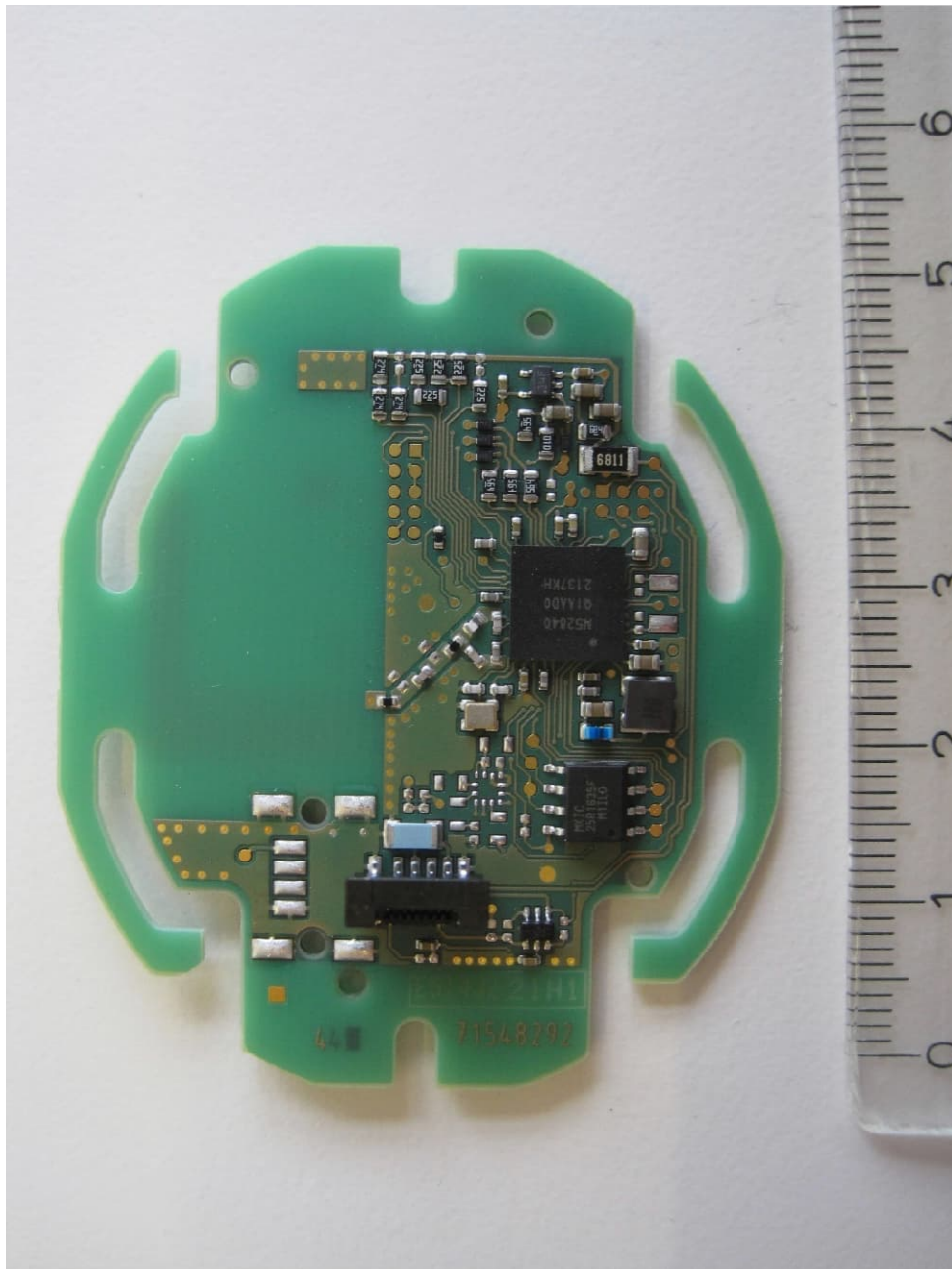
LCD board, bottom view

Internal photographs (supplied be the applicant)



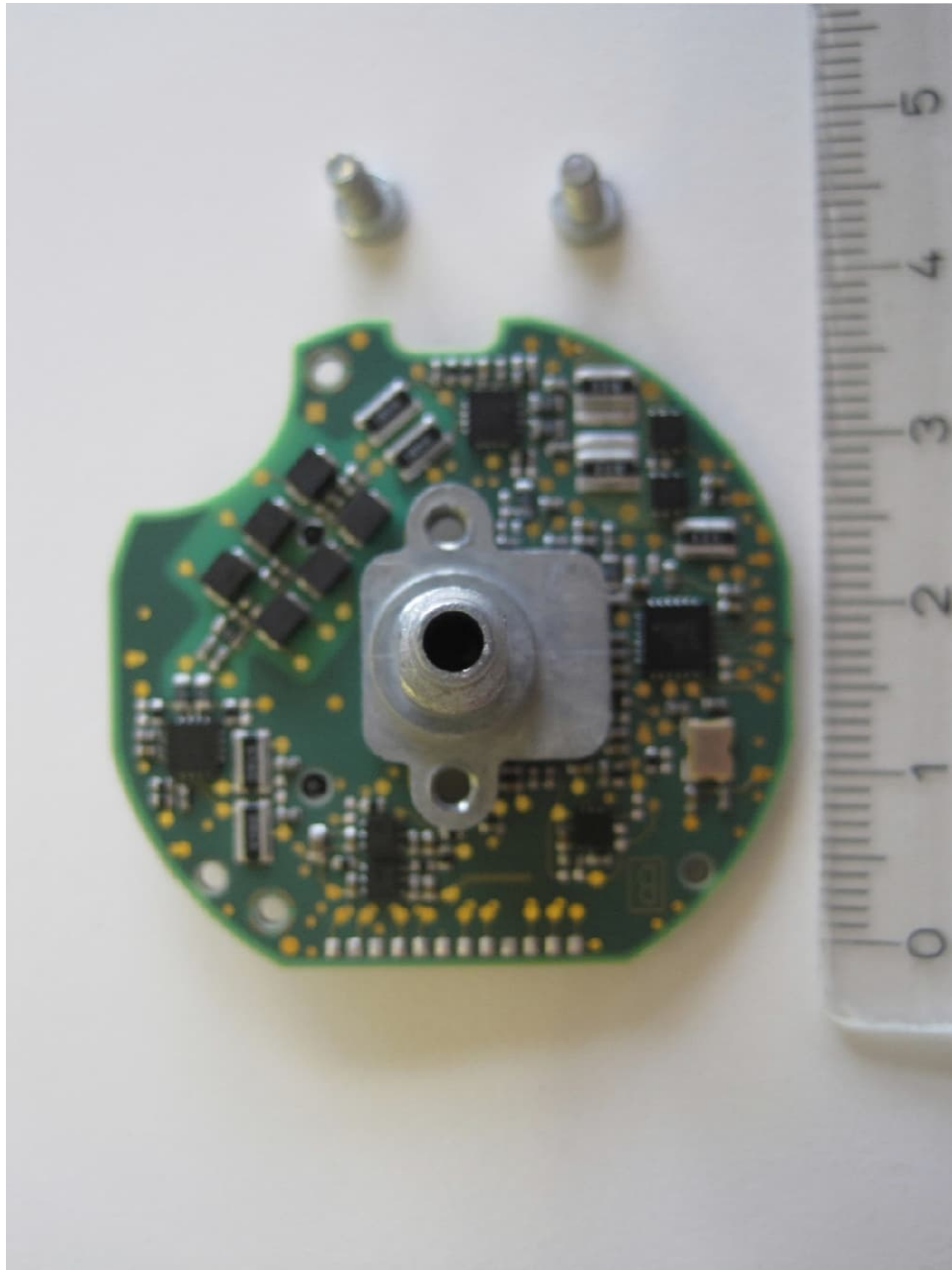
LED board, top view

Internal photographs (supplied be the applicant)



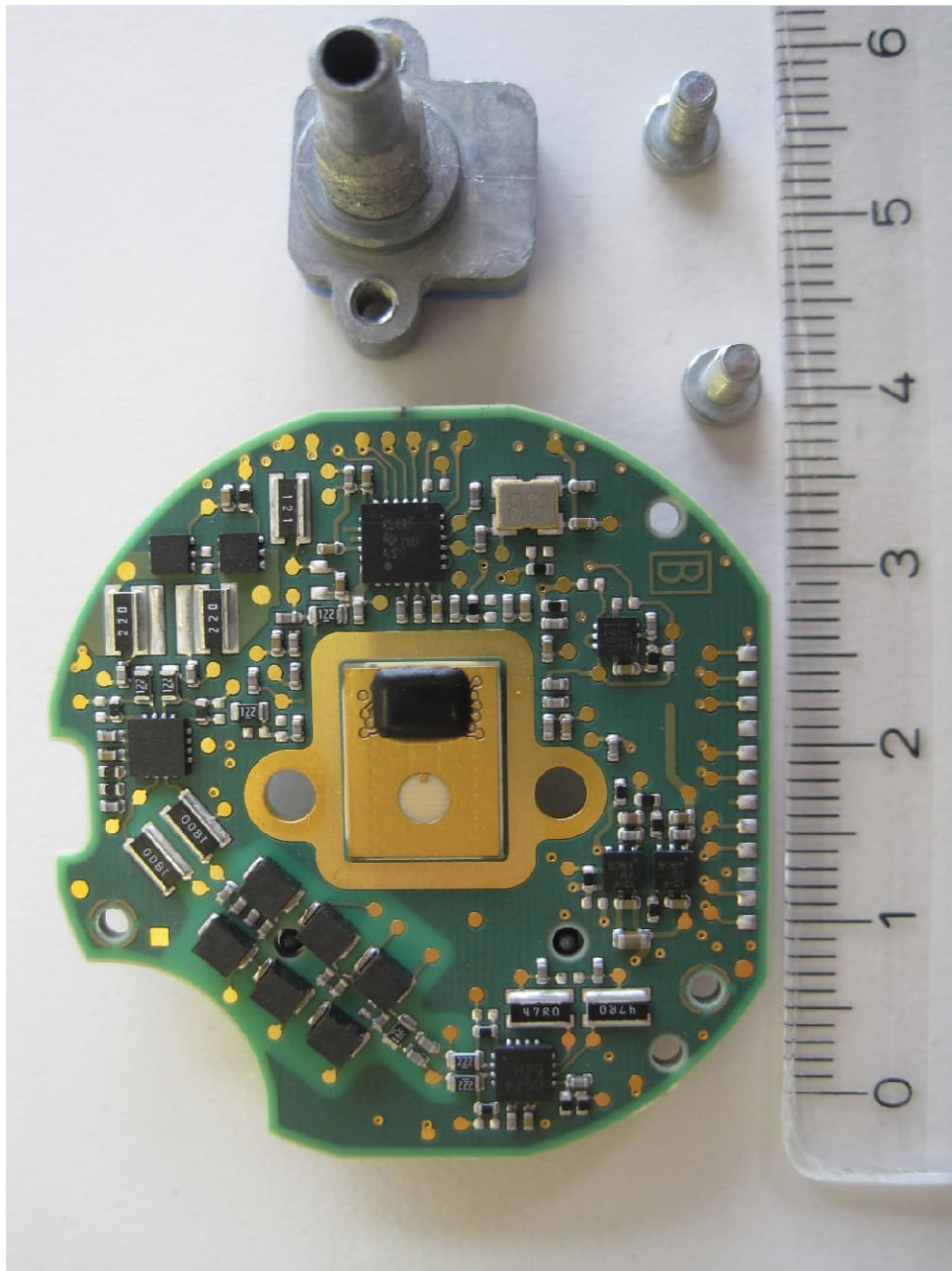
LED board, bottom view

Internal photographs (supplied be the applicant)



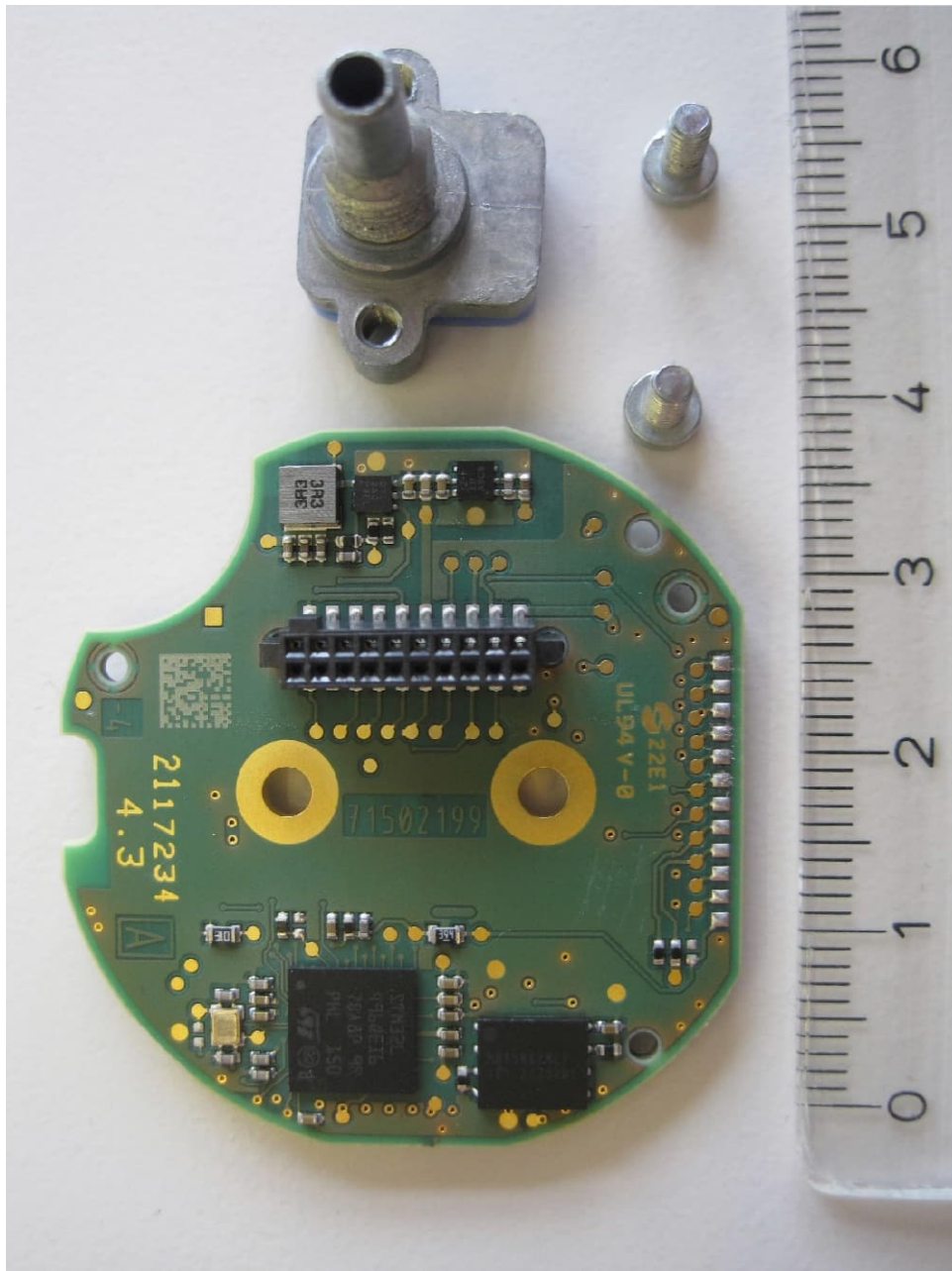
Sensor board, top view

Internal photographs (supplied be the applicant)



Sensor board, top view, wave guide removed

Internal photographs (supplied by the applicant)



Sensor board, bottom view